

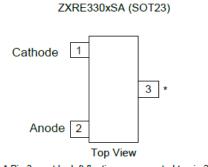
### Description

The ZXRE330 is a low knee current 3.3V voltage reference. Offering tight tolerances and sharp knee characteristics – consuming only  $1\mu A$  when the 3.3V reference voltage can no longer be maintained.

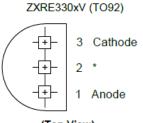
Excellent performance is maintained over the  $1\mu$ A to 5mA operating current range. The device has been designed to be highly tolerant of capacitive loads so maintaining excellent stability.

It's available in small outline SOT23 and TO92 packages. This device offers a pin for pin compatible alternative to industry standard shunt voltage reference.

### **Pin Assignments**



\* Pin 3 must be left floating or connected to pin 2



(Top View)

\* Pin 2 must be left floating or connected to pin 1

### **Features**

- Small Packages: SOT23 & TO92
- No Output Capacitor Required
- Output Voltage Tolerance
- ZXRE330E: ±2% at +25°C
- ZXRE330A: ±0.5% at +25°C
- Low Output Noise
  - 55µV<sub>RMS</sub> (10Hz to 10 kHz)
- Wide Operating Current Range 1µA to 5mA
- Extended Temperature Range -40°C to +85°C
- Low Temperature Coefficient 20ppm/°C (Typ)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

Applications

**Battery-Powered Equipment** 

Portable Communications Devices

Notebook and Palmtop Computers

**Precision Power Supplies** 

Portable Instrumentation

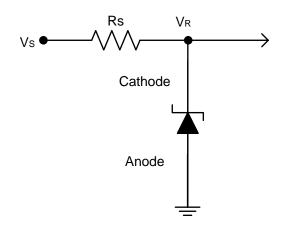
Data Acquisition Systems

Low Current Voltage Clamps

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



## **Typical Applications Circuit**



### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.) (Voltages to GND, unless otherwise stated.)

Parameter	Rating	Unit
Continuous Reverse Current	10	mA
Continuous Forward Current	10	mA
Operating Junction Temperature	-40 to +150	°C
Storage Temperature	-65 to +150	°C

Note: 4. Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum rating, for extended periods, may reduce device reliability. Unless otherwise stated voltages specified are relative to the ANODE pin.

## Package Thermal Data

Package	θ <sub>JA</sub>	P <sub>DIS</sub> T <sub>AMB</sub> = +25°C, T <sub>J</sub> = +150°C
SOT23	415°C/W	300mW
TO92	180°C/W	700mW

## Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Min.	Max.	Unit
Reverse Current	0.002	5	mA
Operating Ambient Temperature Range	-40	+85	°C

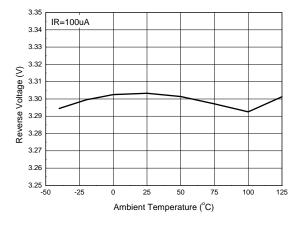


# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

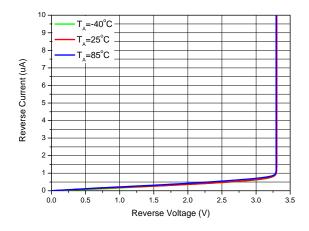
Cumhal	Devenuentes	Conditions			Turn	<b>F</b> Limite	11
Symbol	Parameter	_	Т <sub>АМВ</sub>		Тур	E Limits	Unit
	Reverse Breakdown Voltage	I <sub>R</sub> = 100μΑ	+2	25°C	3.3		V
			ZXRE330A			±16.5	
$V_{REF}$	Reverse Breakdown Voltage Tolerance	I <sub>R</sub> = 100μΑ	+25°C	ZXRE330E	_	±66	mV
			-40 to	o +85°C		±99	
			+2	25°C	0.5	_	
IROFF	Off state Reverse Current	$V = V_{REF} * 0.9$	-40 to	o +85°C	_	1	μA
		I <sub>R</sub> = 5mA	-40 to +85°C		±20		_
$\Delta V_R / \Delta T$	Average Reverse Breakdown Voltage	I <sub>R</sub> = 100μA			±15	±150	ppm/°C
	Temperature Coefficient	Ι <sub>R</sub> = 10μΑ			±15	_	_
		2uA <i<sub>R &lt; 100uA -4</i<sub>	2	25°C			
			-40 to	o +85°C	_	0.6	
ΔV <sub>R</sub>	Reverse Breakdown Change With Current		25°C		10	_	mV
		100uA < I <sub>R</sub> < 5mA	-40 to	-40 to +85°C		20	
I <sub>RMIN</sub>	Minimal Operating Current	_		1	2	μA	
Z <sub>R</sub>	Dynamic Output Impedance	I <sub>R</sub> = 2mA, f = 120Hz, I <sub>AC</sub> = 0.1I <sub>R</sub>		2	_	Ω	
en	Noise Voltage	I <sub>R</sub> = 100μA 10Hz < f < 10kHz		55	_	μV <sub>RMS</sub>	
VR	Long Term Stability (non-cumulative)	t = 1000Hrs, I <sub>R</sub> = 100µA		—	_	ppm	
V <sub>HYST</sub>	Thermal Hysteresis	$\Delta T = -40^{\circ}C$ to $+85^{\circ}C$		0.08	_	%	



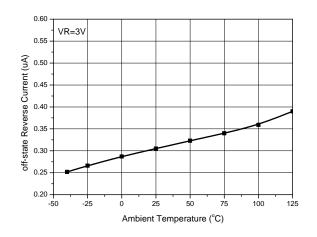
# **Typical Characteristics**



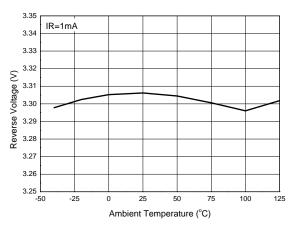
#### Reverse Breakdown Voltage Temperature Coefficient



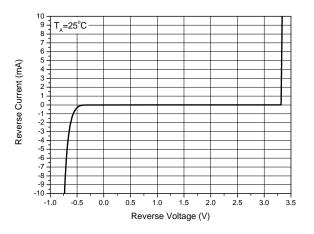




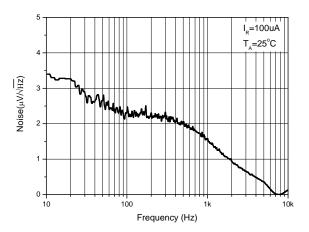
Off-state Reverse Current vs. Temperature



**Reverse Breakdown Voltage Temperature Coefficient** 



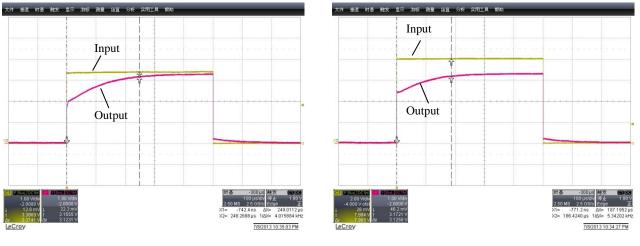
Reverse Current vs. Reverse Voltage



Noise Voltage vs. Frequency



## **Start-up Characteristics ZXRE330**

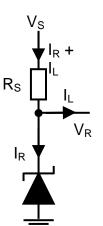


 $I_R$ =100µA, No Load Capacitor

I<sub>R</sub>=5mA, No Load Capacitor

### **Application Information**

In a conventional shunt regulator application (*Figure 1*), an external series resistor ( $R_S$ ) is connected between the supply voltage,  $V_S$ , and the ZXRE330.



 $R_S$  determines the current that flows through the load (I<sub>L</sub>) and the ZXRE330 (I<sub>R</sub>). Since load current and supply voltage may vary,  $R_S$  should be small enough to supply at least the minimum acceptable I<sub>R</sub> to the ZXRE330 even when the supply voltage is at its minimum and the load current is at its maximum value. When the supply voltage is at its maximum and I<sub>L</sub> is at its minimum,  $R_S$  should be large enough so that the current flowing through the ZXRE330 is less than 10mA.

 $R_S$  is determined by the supply voltage, (V<sub>S</sub>), the load and operating current, (I<sub>L</sub> and I<sub>R</sub>), and the ZXRE330's reverse breakdown voltage, V<sub>R</sub>.

$$R_S = \frac{V_S - V_R}{I_L + I_R}$$

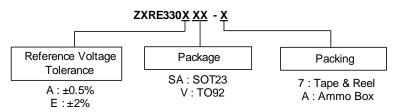
#### Printed Circuit Board Layout Considerations

ZXRE330 in the SOT23 package have the die attached to pin 3, which results in an electrical contact between pin 2 and pin 3. Therefore, pin 3 of the SOT23 package must be left floating or connected to pin 2.

ZXRE330 in the TO92 package have the die attached to pin 2, which results in an electrical contact between pin 2 and pin 1. Therefore, pin 2 must be left floating or connected to pin1.



## Ordering Information

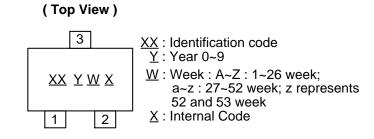


Deut Neurale en	Package		7" Tape and Reel		Ammo Box	
Part Number	Code	Packaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix
ZXRE330ASA-7	SA	SOT23	3,000/Tape & Reel	-7	NA	NA
ZXRE330ESA-7	SA	SOT23	3,000/Tape & Reel	-7	NA	NA
ZXRE330AV-A	V	TO92	NA	NA	2,000/Box	A
ZXRE330EV-A	V	TO92	NA	NA	2,000/Box	А

Note: 5. Pad layout as shown on Diodes Incorporated's package page, which can be found on http://www.diodes.com/package-outlines.html.

### **Marking Information**

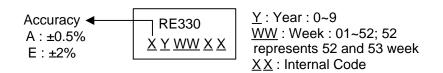
#### (1) SOT23



Part Number	Package	Identification Code
ZXRE330ASA-7	SOT23	DC
ZXRE330ESA-7	SOT23	DD

#### (2) TO92

#### (Top View)

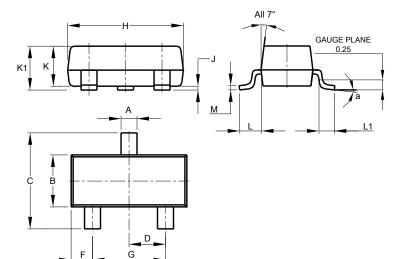




## **Package Outline Dimensions**

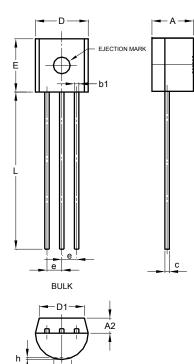
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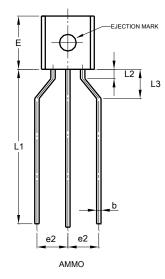
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT23				
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
К	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All	All Dimensions in mm				

TO92





	TO92				
Dim	Min	Max	Тур		
Α	3.45	3.66	-		
A2	1.22	1.37	-		
b	-	-	0.38		
С	-	-	0.38		
D	4.27	4.78	-		
D1	-	-	3.87		
Е	4.32	4.83	-		
е	-	-	1.27		
e2	2.40	2.90	-		
L	12.98	15.00	-		
L1	12.80	15.00	-		
L2	0.80	-	-		
L3	2.00	3.00	-		
All I	All Dimensions in mm				

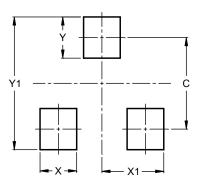
#### SOT23

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## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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